



**REC Limited | आरईसी लिमिटेड**  
(भारत सरकार का उद्यम) / (A Government of India Enterprise)  
Regd. Office: Core-4, SCOPE Complex, 7, Lodhi Road, New Delhi - 110003  
Corporate Office: Plot No. I-4, Near IFFCO Chowk Metro Station,  
Sector-29, Gurugram - 122001 (Haryana)  
Tel: +91 124 444 1300 | Website: www.recindia.nic.in  
CIN : L40101DL1969GOI005095 | GST No.: 06AAACR4512R3Z3



**Mandatory furnishing of PAN, Nomination, Contact Details, Bank A/c Details and Specimen Signature by holders of physical securities.**

Pursuant to SEBI Circular no. SEBI/HO/MIRSD-PoD-1/P/CIR/2023/37 dated 16.03.2023 as amended by SEBI Circular No SEBI/HO/MIRSD-PoD-1/P/CIR/2024/37 dated 07.05.2024, it is mandatory for all the holders of physical debt securities to provide PAN, Nomination, Contact Details, Bank A/c Details and Specimen Signature for their investments held in physical mode.

Investors may contact the following for Updation of their details:

Type of Bonds	Tax Free Bonds	Infrastructure Bonds
RTA Name	KFin Technologies Limited	Beetal Financial & Computer Services Pvt. Ltd.
Toll Free Number	1800 309 4001 (Monday-Friday: 9:00 AM to 7:00 PM)	011-29961281/ 011-29961282 (Monday to Friday: 10 AM to 6 PM)
Email	einward.ris@kfintech.com	recbonds4@gmail.com
Address	M/s KFIN Technologies Ltd. (Unit: REC – 54EC Bonds) Ground Floor, Selenium Tower B, Plot No. 31 & 32, Financial District, Nanakramguda, Serilingampally Mandal Hyderabad - 500032	BEETAL Financial & Computer Services Pvt. Ltd. (Unit - REC Infrastructure Bonds) BEETAL House, 3rd Floor, 99 Madangir Behind LSC Opp Dada Harsukhdas Mandir New Delhi - 110062

Particulars	REC Limited
Toll Free Number	1800 180 2992 (Monday to Friday: 10 AM to 6 PM)
Email	<a href="mailto:investorcell@recl.in">investorcell@recl.in</a>
Address	Plot No I-4, A Block - 2nd Floor, Retail Bond Division, REC World Headquarters, IFFCO Chowk, Sector-29, Gurugram – 122001

**Raj Kumar Sonkar**  
**Sr. GM & HOD (Finance)**

**Note-** The above notice shall not constitute an offer to public for subscription for the said bonds.